



- NOTES:
- MATERIAL:
 - 1.1 HOUSING: Δ THERMOPLASTIC, (PA66)
 - Δ THERMOPLASTIC, (PA46)
 - UL94V-0; COLOR: SEE TABLE.
 - FINISH:
 - 1.2 CONTACTS: Δ BRASS; Δ PHOSPHOR BRONZE
 - CONTACT:
 - GOLD PLATING (SEE TABLE) ON CONTACT AREA
 - 100 μ " MIN. MATTE TIN PLATING ON SOLDER TAIL AREA,
 - 50 μ " MIN. NICKEL UNDERPLATING OVERALL.
 - RECOMMENDED PCB THICKNESS : 1.6mm
 - WAVE SOLDER CAPABLE TO 240°C
 - PER TYCO SPEC. 109-202, CONDITION A
 - WAVE SOLDER CAPABLE TO 265°C
 - PER TYCO SPEC. 109-202, CONDITION B.
5. SPECIFICATION:
- CURRENT RATING: 1A MAX
 - VOLTAGE: 125VAC
 - TEMPERATURE RANGE: -55°C~105°C
 - CONTACT RESISTANCE: 30 MILLIOHM MAX.
 - DIELECTRIC WITHSTANDING VOLTAGE: 500VAC r.m.s
 - INSULATION RESISTANCE: 1000 MEGOHMS MIN.

CONTACT MATERIAL	HOUSING MATERIAL	GOLD PLATING	HSG. COLOR	PART NUMBER
Δ	Δ	30 μ " MIN.	YELLOW 115C	3-- 1-- -6
Δ	Δ	30 μ " MIN.	WHITE	3-- -5
Δ	Δ	30 μ " MIN.	YELLOW 115C	1-- -6
Δ	Δ	30 μ " MIN.	WHITE	1-- -5
Δ	Δ	15 μ " MIN.	YELLOW 115C	1-- -4
Δ	Δ	15 μ " MIN.	WHITE	1-- -3
Δ	Δ	GOLD FLASH	SLUE 2945C	1-- -7
Δ	Δ	GOLD FLASH	YELLOW 115C	1-- -2
Δ	Δ	GOLD FLASH	WHITE	1--1734019-1
Δ	Δ	30 μ " MIN.	YELLOW 115C	1-- -6
Δ	Δ	30 μ " MIN.	WHITE	1-- -5
Δ	Δ	15 μ " MIN.	YELLOW 115C	1-- -4
Δ	Δ	15 μ " MIN.	WHITE	1-- -3
Δ	Δ	GOLD FLASH	YELLOW 115C	1-- -2
Δ	Δ	GOLD FLASH	WHITE	1734019-1

TYCO	DATE	BY	CHKD	APP'D	REV	DESCRIPTION
11AUG	2006				1	INITIAL RELEASE
23MAR	2006				2	
19AUG	2005				3	
03DEC	2004				4	
25JUN	2004				5	
11AUG	2006				6	
23MAR	2006				7	
19AUG	2005				8	
03DEC	2004				9	
25JUN	2004				10	

TYCO	DATE	BY	CHKD	APP'D	REV	DESCRIPTION
11AUG	2006				1	INITIAL RELEASE
23MAR	2006				2	
19AUG	2005				3	
03DEC	2004				4	
25JUN	2004				5	

TYCO	DATE	BY	CHKD	APP'D	REV	DESCRIPTION
11AUG	2006				1	INITIAL RELEASE
23MAR	2006				2	
19AUG	2005				3	
03DEC	2004				4	
25JUN	2004				5	

PCI, CARD EDGE 120P,
CONT. TYPE.

A₃ C-1734019 C

12 GRAMS

1 OF 2

